

	Type	Hits	Search Text	DBs	Time Stamp
1	BRS	94	(257/758 or 257/759 or 257/760) and wafer and (trench or hole or open or opening or via) near (edge or peripheral)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/04 12:55
2	BRS	43	(257/758 or 257/759 or 257/760) and wafer same (trench or hole or open or opening or via) with (edge or peripheral)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/04 12:56
3	BRS	43	(257/758 or 257/759 or 257/760) and wafer same (trench or hole or open or opening or via) with (edge or peripheral)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/04 12:57
4	BRS	34	(257/761 or 257/762 or 257/751) and wafer same (trench or hole or open or opening or via) with (edge or peripheral)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/04 12:58

	Type	Hits	Search Text	DBs	Time Stamp
5	BRS	27	(257/754 or 257/755 or 257/756 or 257/757) and wafer same (trench or hole or open or opening or via) with (edge or peripheral)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM-TDB	2004/03/04 12:58